

## Renesas RA Family

# RA AWS MQTT/TLS Cloud Connectivity Solution - Cellular

### Introduction

This application note describes IoT Cloud connectivity solution in general, provides a brief introduction to IoT Cloud providers like Amazon Web Services (AWS), and covers the FSP MQTT/TLS module and its features. The application example provided in the package uses AWS IoT Core. The detailed steps in this document show first-time AWS IoT Core users how to configure the AWS IoT Core platform to run this application example.

This application note enables developers to effectively use the FSP MQTT/TLS modules in end-product design. Upon completion of this guide, developers will be able to add the “AWS Core MQTT”, “Mbed TLS”, and “AWS Cellular Sockets Wrapper” using the Cellular interface, configure them correctly for the target application, and write code using the included application example code as a reference for an efficient starting point.

References to detailed API descriptions, and other application projects that demonstrate more advanced uses of the module, are in the *FSP User’s Manual* (available at: <https://renesas.github.io/fsp/>), which serves as a valuable resource in creating more complex designs.

This MQTT/TLS AWS Cloud Connectivity solution is supported on the [CK-RA6M5 Kit](#).

### Applies to:

RA6M5 MCU Group

### Required Resources

To build and run the MQTT/TLS application example, the following resources are needed.

#### Development tools and software

- Flexible Software Package (FSP) v5.0.0 and required tools ([renesas.com/us/en/software-tool/flexible-software-package-fsp](https://renesas.com/us/en/software-tool/flexible-software-package-fsp))

#### Hardware

- Renesas CK-RA6M5 kit ([renesas.com/ra/ck-ra6m5](https://renesas.com/ra/ck-ra6m5))
- PC running Windows® 10 and an installed web browser (Google Chrome, Internet Explorer, Microsoft Edge, Mozilla Firefox, or Safari)
- Micro USB cables (included as part of the kit. See *CK-RA6M5 — User’s Manual*)
- Renesas LTE Cat-M1 Cellular IoT Module (Included in the CK-RA6M5 Kit) ([RYZ014A - LTE Cat-M1 Cellular IoT Module | Renesas](#))

## Prerequisites and Intended Audience

This application note assumes that the user is adept at operating the Renesas e<sup>2</sup> studio IDE with Flexible Software Package (FSP). If not, we recommend reading and following the procedures in the *FSP User's Manual* sections for 'Starting Development' including 'Debug the Blinky Project'. Doing so enables familiarization with e<sup>2</sup> studio and FSP and validates proper debug connection to the target board. In addition, this application note assumes prior knowledge of MQTT/TLS and its communication protocols and knowledge of Cellular modems.

The intended audience is users who want to develop applications with MQTT/TLS modules using Cellular modules on Renesas RA6 MCU Series.

**Note:** If you are a first-time user of e<sup>2</sup> studio and FSP, we highly recommend you install e<sup>2</sup> studio and FSP on your system to run the Blinky Project and to get familiar with the e<sup>2</sup> studio and FSP development environment before proceeding to the next sections.

**Note:** This Application Project and Application Note can only use versions FSP v5.0.0.

**Note:** If you want to quickly build and run the attached application, please jump to section (2 Running the MQTT/TLS Cellular Application Example).

### Prerequisites

1. Access to online documentation available in the Cloud Connectivity References section.
2. Access to latest documentation for identified Renesas Flexible Software Package.
3. Prior knowledge of operating e<sup>2</sup> studio and built-in (or standalone) RA Configurator.
4. Access to associated hardware documentation such as User Manuals, Schematics, and other relevant kit information ([renesas.com/ra/ck-ra6m5](https://renesas.com/ra/ck-ra6m5)).

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## 1. Introduction to Components for Cloud Connectivity

### 1.1 General Overview

The Internet-of-Things (IoT) is a global infrastructure for the information society, enabling advanced services by interconnecting (physical and virtual) things based on existing and evolving interoperable information and communication technologies. The ‘things’ in this definition are objects in the physical world (physical objects) or information world (virtual) that can be identified and integrated into communication networks. In the context of the IoT, a ‘device’ is a piece of equipment with the mandatory capabilities of communication and the optional capabilities of sensing, actuation, data capture, data storage and data processing. Communication is often performed with providers of network-hosted services, infrastructure, and business applications to process/analyze the generated data and manage the devices. Such providers are called Cloud Service Providers. While there are many manufacturers for devices and cloud service providers, for the context of this application note, the device is a Renesas RA Microcontroller (MCU) connecting to services provided by Amazon Web Services (AWS) for IoT.

### 1.2 Cloud Service Provider

[AWS IoT](#) provides the cloud services that connect your IoT devices to other devices and AWS cloud services. As a Cloud Service Provider, AWS IoT provides the ability to:

- Connect and manage devices
- Secure device connections and data
- Process and act upon device data
- Read and set device state at any time

Figure 1 summarizes the features provided by AWS IoT.

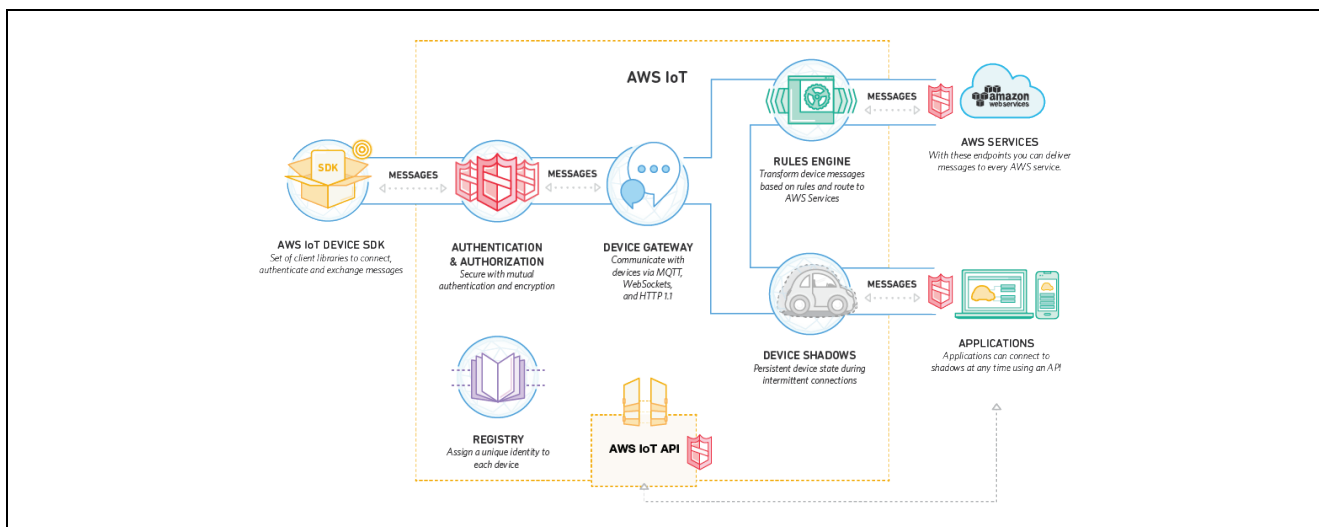


Figure 1. AWS IoT Features, Service Components, and Data Flow Diagram

A key feature provided by AWS is the AWS IoT Software Development Kit (SDK) written in C, which allows devices such as sensors, actuators, embedded micro-controllers, or smart appliances to connect, authenticate, and exchange messages with AWS IoT using the MQTT, HTTP, or WebSocket's protocols. This application note focuses on configuring and using the AWS IoT Device SDK and the included MQTT protocol available through the Renesas Flexible Software Package (FSP) for Renesas RA MCUs.

### 1.3 Cloud Dashboard

A cloud dashboard is a monitoring and controlling GUI for the multiple services, that you can build and access on a web browser. It has key advantages over on-premises software such as being easier to deploy, requiring little to no IT support and is accessible on multiple devices.

The **Dashboard** provides a high-level view of your entire fleet of devices and allows you to act on individual devices quickly. You can view graphical representations of relevant device information for your fleet, such as device ownership type, compliance statistics, and platform and OS breakdowns. You can access each set of devices in the presented categories by selecting any of the available data views from the **Device Dashboard**.

#### 1.3.1 Data Monitoring

Data monitoring on the dashboard is a cloud data analytics monitoring solution that lets you track your performance metrics and easily visualize your data sets. You will be able to get a high-level view of your metrics, or you can drill down and analyze the detail.

For instance, it can be sensor data coming from the device in the form of temperature, pressure, and so forth.

#### 1.3.2 Device Management

**Device Management** provides high-level control to configure the devices in bulk for the entire fleet of devices or to control the individual devices.

Note: All the Dashboard-specific details for this Application Project are discussed in the *(RA AWS Cloud Connectivity on CK-RA6M5 with Cellular – Getting Started Guide)* document.

### 1.4 AWS IoT Core

[AWS IoT Core](#) is a managed cloud service that lets connected devices easily and securely interact with cloud applications and other devices. AWS IoT Core can support billions of devices and trillions of messages. It can process and route messages to AWS endpoints and to other devices reliably and securely. With AWS IoT Core, customer applications can keep track of all devices, all the time, even when devices are not connected.

AWS IoT Core addresses security concerns for the infrastructure by implementing mutual authentication and encryption. AWS IoT Core provides automated configuration and authentication upon a device's first connection to AWS IoT Core, as well as end-to-end encryption throughout all points of connection, so that data is only exchanged between devices and AWS IoT Core with proven identity.

This application note focuses on complementing the security needs of AWS IoT Core through installing a proven identity for the RA MCU by storing a X.509 certificate and asymmetric cryptography keys in Privacy Enhanced Mail (PEM) format in the on-board flash. The RA MCU has on-chip security features, such as Key Wrapping, to protect the private key associated with the public key and the certificate associated with the device<sup>1</sup>. Additionally, RA MCUs can also generate asymmetric keys using features of the Secure Cryptography Engine (SCE) and API available through the FSP. The SCE accelerates symmetric encryption/decryption of data between the connected device and AWS IoT, allowing the ARM Cortex-M processor to perform other application specific computations.

### 1.5 MQTT Protocol Overview

This application notes features Message Queuing Telemetry Transport (MQTT) as it is a lightweight communication protocol specifically designed to tolerate intermittent connections, minimize the code footprint on devices, and reduce network bandwidth requirements. MQTT uses a publish/subscribe architecture which is designed to be open and easy to implement, with up to thousands of remote clients capable of being supported by a single server. These characteristics make MQTT ideal for use in constrained environments

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<sup>1</sup> This application note does not focus on using Key Wrapping for securely storing the private key for devices deployed in a production environment.

where network bandwidth is low or where there is high latency and with remote devices that might have limited processing capabilities and memory. The RA MCU device in this application note implements a Core MQTT service which communicates with AWS IoT and exchanges example telemetry information, such as temperature, pressure, humidity, accelerometer, magnetometer and many more types of sensor data.

## 1.6 TLS Protocol Overview

The primary goal of the Transport Layer Security (TLS) protocol is to provide privacy and data integrity between two communicating applications or endpoints. AWS IoT mandates use of secure communication. Consequentially, all traffic to and from AWS IoT is sent securely using TLS. TLS protocol version 1.2 or later ensures the confidentiality of the application protocols supported by AWS IoT. A variety of TLS Cipher Suites are supported. This application note configures the RA Flexible Software Package for the MCU based device to provide the following capabilities and AWS IoT negotiates the appropriate TLS Cipher Suite configuration to maximize security.

**Table 1. TLS with Crypto Capabilities in RA FSP**

Secure Crypto Hardware Acceleration	Supported
Key Format Supported	AES, ECC, RSA
Hash	SHA-256
Cipher	AES
Public Key Cryptography	ECC, ECDSA, RSA
Message Authentication Code (MAC)	HKDF

On top of these supported features, Mbed Crypto middleware also supports a variety of features which can be enabled through the RA Configurator. Refer to the *FSP User's Manual* section for the Crypto Middleware (rm\_psa\_crypto).

## 1.7 Device Certificates, CA, and Keys

Device Certificates, Certificate Authorities (CA), and Asymmetric Key Pairs create the foundation for trust needed for a secure environment. The background information on these commonly used components in AWS is provided in this section.

A *digital certificate* is a document in a known format that provides information about the identity of a device. The X.509 standard includes the format definition for public-key certificate, attribute certificate, certificate revocation list (CRL), and attribute certificate revocation list (ACRL). X.509-defined certificate formats (X.509 Certificates) are commonly used on the internet and in AWS IoT for authenticating a remote entity/endpoint, that is, a Client and/or Server. In this application note, an X.509 certificate and asymmetric cryptography key pair (public and private keys) are generated from AWS IoT and installed (during binary compilation) into the RA MCU device running the Core MQTT to establish a *known identity*. In addition, a root Certification Authority (CA) certificate is also downloaded and used by the device to authenticate the connection to the AWS IoT gateway.

*Certification authority (CA)* certificates are certificates that are issued by a CA to itself or to a second CA for the purpose of creating a defined relationship between the two CAs. The root CA certificate allows devices to verify that they're communicating with AWS IoT Core and not another server impersonating AWS IoT Core.

The public and private keys downloaded from AWS IoT use RSA algorithms for encryption, decryption, signing and verification<sup>2</sup>. These key pairs, and certificates are used together in the TLS process to:

1. Verify device identity.
2. Exchange symmetric keys, for algorithms such as AES, for encrypting and decrypting data transfers between endpoints.

<sup>2</sup> Public Key length used is 2048 bits.

## 2. Running the MQTT/TLS Cellular Application Example

Refer to *RA AWS Cloud Connectivity on CK-RA6M5 with Cellular - Getting Started Guide* as part of this project bundle for details on running the project and visualizing the sensor data on Renesas AWS dashboard.

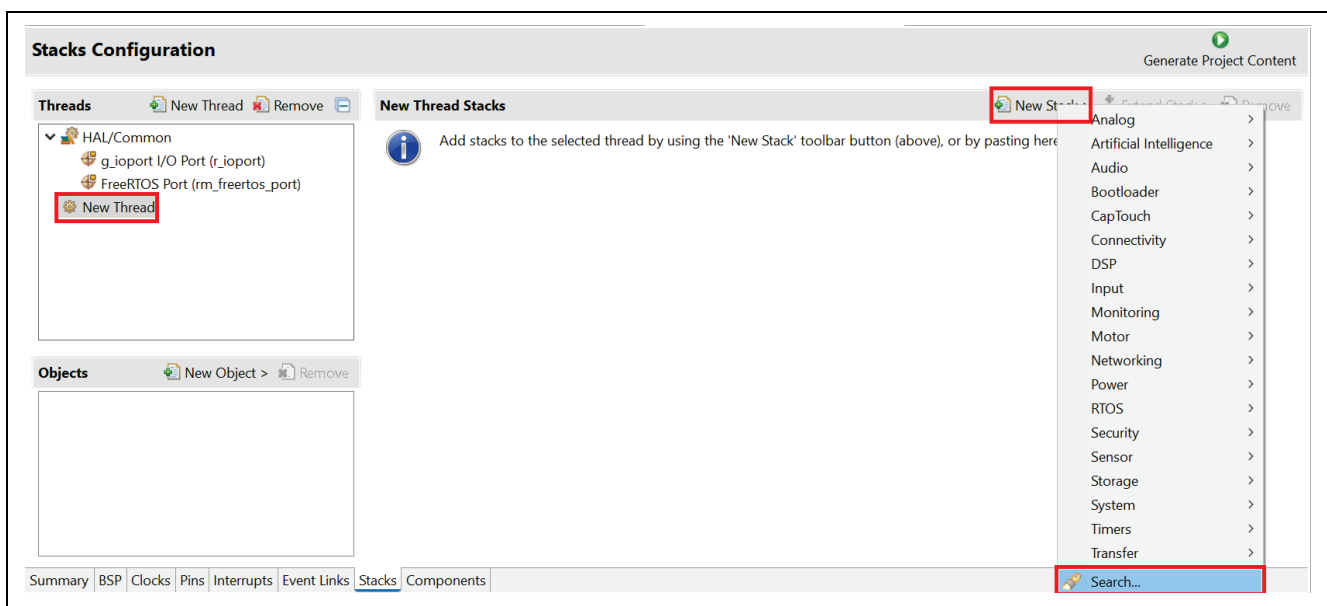
### 3. AWS Core MQTT with Cellular Interface

#### 3.1 AWS Core MQTT

The AWS MQTT library included in RA FSP can connect to either AWS MQTT or to any third party MQTT broker such as Mosquitto. The complete documentation for the library can be found on the [AWS IoT Device SDK C](#): MQTT website. Primary features supported by the library are:

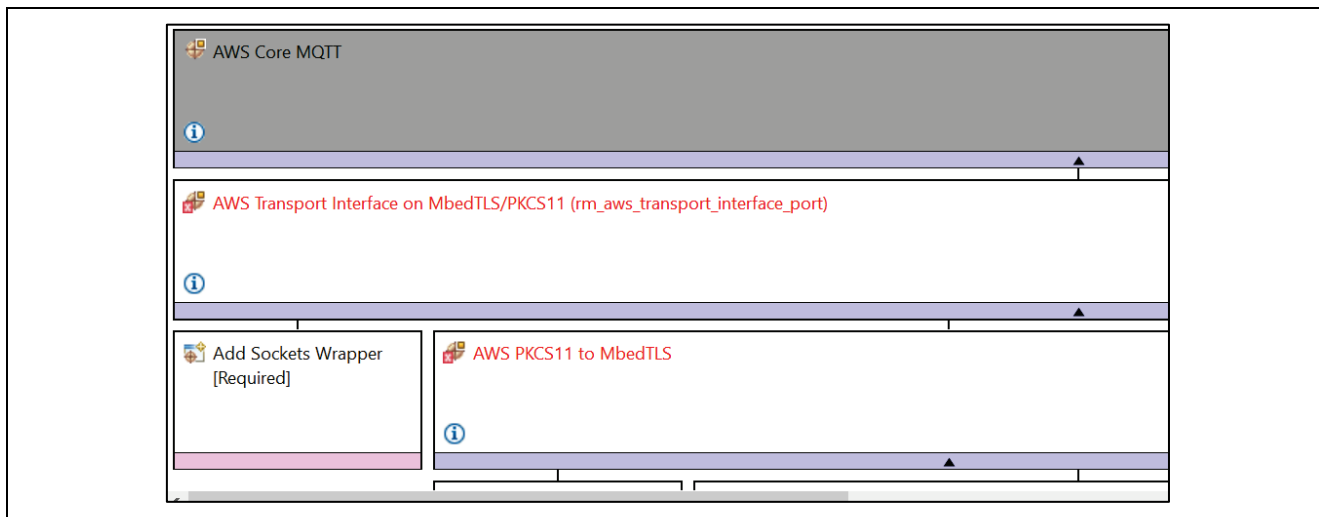
- MQTT connections over TLS to an AWS IoT Endpoint or Mosquitto server or other MQTT broker.

The AWS Core MQTT can be directly imported into a **Thread** stack. It is configured through the RA Configuration Perspective. To add the AWS Core MQTT to a new thread, open `Configuration.xml` with the RA Configuration. While ensuring that the correct thread is selected on the left, use the tab for **Stacks > New Stack > Search** and search for the keyword AWS Core MQTT.



**Figure 2. AWS Core MQTT Module Selection**

Adding the AWS Core MQTT stack results in the default configuration with *some unmet dependencies*, as shown in the following Figure 3. FSP offers different Transport interfaces to the users. In this application note we will be covering the Cellular Interface which uses the *AWS Transport Interface on MbedTLS/PKCS11* as shown in the Figure 4.



**Figure 3. AWS Core MQTT Stack View**

While the AWS Core MQTT stack shown contains a lot of dependencies and configurable properties, most default settings can be used as-is. The following change is needed to meet all unmet dependencies (marked in red) for the AWS Core MQTT stack added to a new project (as shown above):

- Enable Mutex and Recursive Mutex usage support as needed by IoT SDK and FreeRTOS in the created Thread properties.

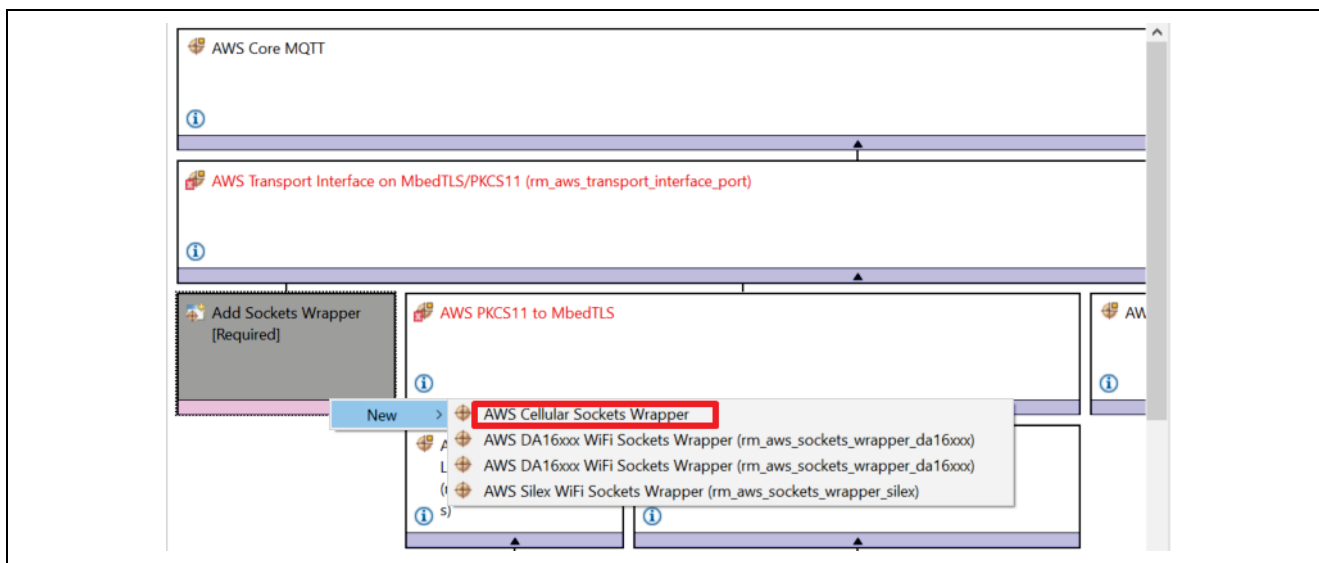
Upon completion of the above step, the AWS Core MQTT is ready to accept a socket implementation, which has dependencies on using a TLS Session and an underlying TCP/IP implementation.

Additional documentation on the AWS Core MQTT is available in the *FSP User's Manual* under *RA Flexible Software Package Documentation > API Reference > Modules > Networking > AWS MQTT*.

### 3.2 Transport Layer Implementation

The FSP AWS Transport Interface provides options for Wi-Fi, Cellular, and Ethernet. **AWS Transport Interface on MbedTLS11** module is used for the Cellular Interface. While the RA FSP contains a Secure Socket Implementation for both Wi-Fi and Ethernet, this application and application note focuses on the use of the Cellular Interface.

Cellular Sockets can be added to the Thread Stack by clicking on **Add Sockets Wrapper > New > AWS Cellular Sockets Wrapper**.



**Figure 4. Adding Cellular Interface to the Core MQTT Module**

Upon addition, the needed stack is complete and has unmet dependencies for the dependent modules.

Now, hover the cursor over the red blocks and the error will pop up. Make the appropriate settings.

- AWS Transport Interface on MbedTLS/PKCS11 errors:**  
 For error: *Requires FreeRTOS heap implementation 4 or 5*, choose the heap implementation using **New Stack > RTOS > FreeRTOS Heap 4**. Also, set **Dynamic Memory allocation** in Thread's properties: using **New Thread > Properties > Common > Memory Allocation > Support Dynamic Allocation > Enabled**.  
 For error: *Mutexes must be enabled in the FreeRTOS thread*, enable mutexes in Thread's properties: using **New Thread > Properties > Common > General > Use Mutexes > Enabled**.
- For **AWS PKCS11 to MbedTLS error: MBEDTLS\_CMAC\_C must be defined**, using **MbedTLS (Crypto Only) > Common > Message Authentication Code (MAC) > MBEDTLS\_CMAC\_C > Define**.
- For **MbedTLS error: MBEDTLS\_ECDH\_C must be defined**, using **MbedTLS (Crypto Only) > Common > Public Key Cryptography (PKC) > ECC > MBEDTLS\_ECDH\_C > Define**.
- MbedTLS (Crypto Only) errors relate to minimum RTOS heap**, set Heap Memory allocation using **New Thread > Properties > Common > Memory Allocation > Total Heap Size > 0x20000**.
- For **LittleFS error: A heap is required to use Malloc**, add heap under **BSP Tab > Properties > RA Common > Heap size (bytes) > 0x20000**.
- Mutexes must be enabled using **New Thread > Common > General > Use Mutexes > Enabled**
- Mutexes must be enabled using **New Thread > Common > General > Use Recursive Mutexes > Enabled**.
- For **AWS Cellular Platform error: xTimerPendFunctionCall must be enabled**, set **xTimerPendFunctionCall() function** in Thread's properties: using **New Thread > Properties > Common > Optional Functions > xTimerPendFunctionCall() function > Enabled**.
- UART specific errors can be resolved by enabling the Flow control and selecting the appropriate RTS and CTS pin selection.

Note: These are the basic settings required to remove the error from the configurator. More specific configurations are listed in the specific module and its usage.

After all the appropriate settings have taken care of the errors due to the missing configuration, the new configurator screenshot looks clean with no errors as shown in the Figure 5.

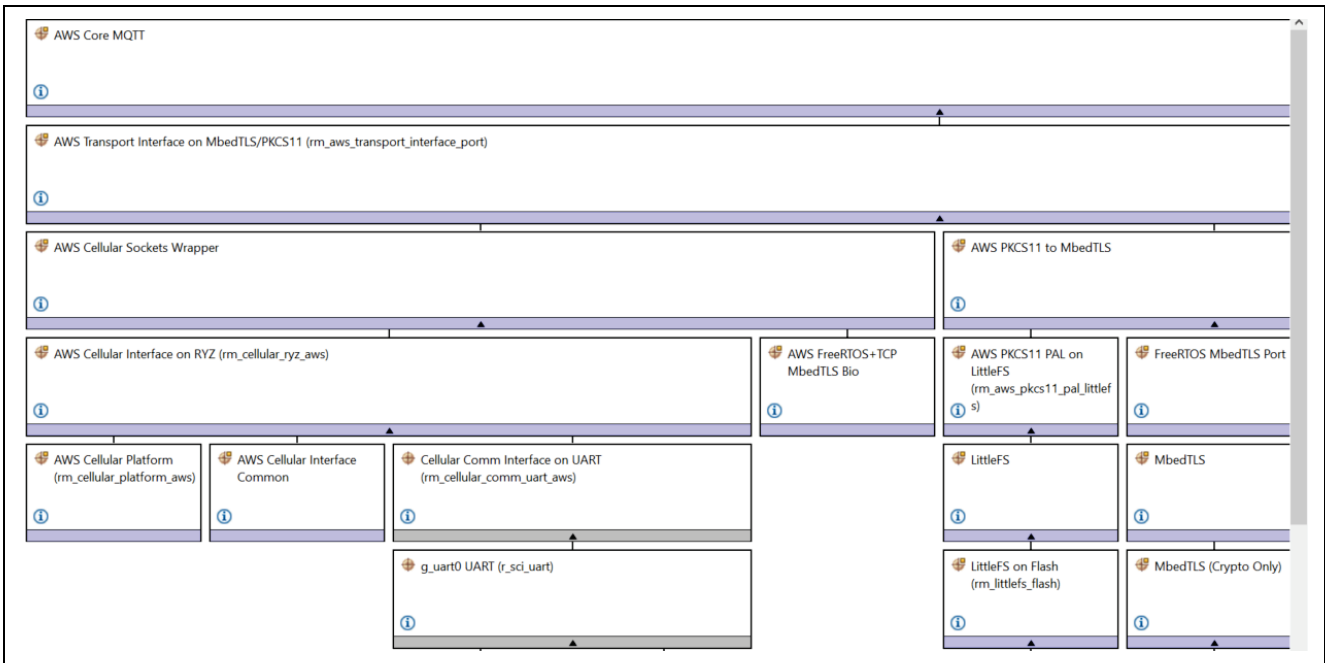


Figure 5. Expanded Cellular Socket Interface Module



### 3.3 Mbed TLS

Mbed TLS is Arm®'s implementation of the TLS protocols as well as the cryptographic primitives required by those implementations. Mbed TLS is also solely used for its cryptographic features even if the TLS/SSL portions are not used.

TLS Support uses FreeRTOS+Crypto which eventually uses Mbed TLS. Use of Mbed TLS requires configuration and operation of the Mbed Crypto module which in turn operates the SCE on the MCU.

The following underlying mandatory changes are needed to the project using the Cellular Sockets on FreeRTOS+Crypto module:

1. Use FreeRTOS heap implementation scheme 4 (first fit algorithm with coalescence algorithm) or scheme 5 (first fit algorithm with coalescence algorithm with heap spanning over multiple non-adjacent/non-contiguous memory regions).
2. Enable support for dynamic memory allocation in FreeRTOS.
3. Enable Mbed TLS platform memory allocation layer.
4. Enable the Mbed TLS generic threading layer that handles default locks and mutexes for the user and abstracts the threading layer to use an alternate thread-library.
5. Enable Elliptic Curve Diffie Hellman (ECDH) library.
6. Change FreeRTOS Total Heap Size to a value greater than 0x20000.
7. Add Persistent Storage on LittleFS.

Additional documentation on the Mbed TLS is available in the *FSP User's Manual* under *RA Flexible Software Package Documentation > API Reference > Modules > Security > Mbed Crypto H/W Acceleration (rm\_psa\_crypto)*.

### 3.4 MQTT Module APIs Usage

Table 2 lists APIs provided by AWS Core MQTT that are used as a part of the Application Example.

**Table 2. MQTT Module APIs**

API	Description
<b>MQTT_Init</b>	Initializes an MQTT context
<b>MQTT_Connect</b>	Establishes an MQTT session
<b>MQTT_Subscribe</b>	Sends MQTT SUBSCRIBE for the given list of topic filters to the broker
<b>MQTT_Publish</b>	Publishes a message to the given topic name
<b>MQTT_Ping</b>	Sends an MQTT PINGREQ to broker
<b>MQTT_Unsubscribe</b>	Sends MQTT UNSUBSCRIBE for the given list of topic filters to the broker
<b>MQTT_Disconnect</b>	Disconnect an MQTT session
<b>MQTT_ProcessLoop</b>	Loop to receive packets from the transport interface. Handles keep-alive
<b>MQTT_ReceiveLoop</b>	Loop to receive packets from the transport interface. Does not handle keep-alive
<b>MQTT_GetPacketId</b>	Get a packet ID that is valid according to the MQTT 3.1.1 specification.
<b>MQTT_MatchTopic</b>	A utility function that determines whether the passed topic filter and topic name match according to the MQTT 3.1.1 protocol specification.
<b>MQTT_GetSubAckStatusCodes</b>	Parses the payload of an MQTT SUBACK packet that contains status codes corresponding to topic filter subscription requests from the original subscribe packet
<b>MQTT_Status_strerror</b>	Error code to string conversion for MQTT statuses.

## 4. Cloud Connectivity Application Example

### 4.1 Overview

This application project demonstrates the use of APIs available through the Renesas FSP-integrated modules for Amazon IoT SDK C, Mbed TLS module, Amazon FreeRTOS, and HAL Drivers operating on Renesas RA MCUs. Network connectivity is established using Cellular module. The application running on a Renesas Cloud Kit also serves as a guide for the operation of Core MQTT, Mbed TLS/Crypto, and Cellular configuration, using the FSP configurator. The application may be used as a starting point for inspiring other customized cloud-based solutions using Renesas RA MCUs. In addition, it simply demonstrates the operation and setup of cloud services available through the cloud service provider.

The upcoming sub-sections show step-by-step creation of a device and security credentials policies as required by the AWS IOT on the cloud side to communicate with the end devices. The example accompanying this documentation demonstrates the Subscribe and Publish messaging between Core MQTT and MQTT Broker, on demand publication of sensor data, and asynchronous publication of a “sensor data” event from the MCU to the Cloud. The device is also subscribed to receive actuation events (LED indication) from the Cloud.

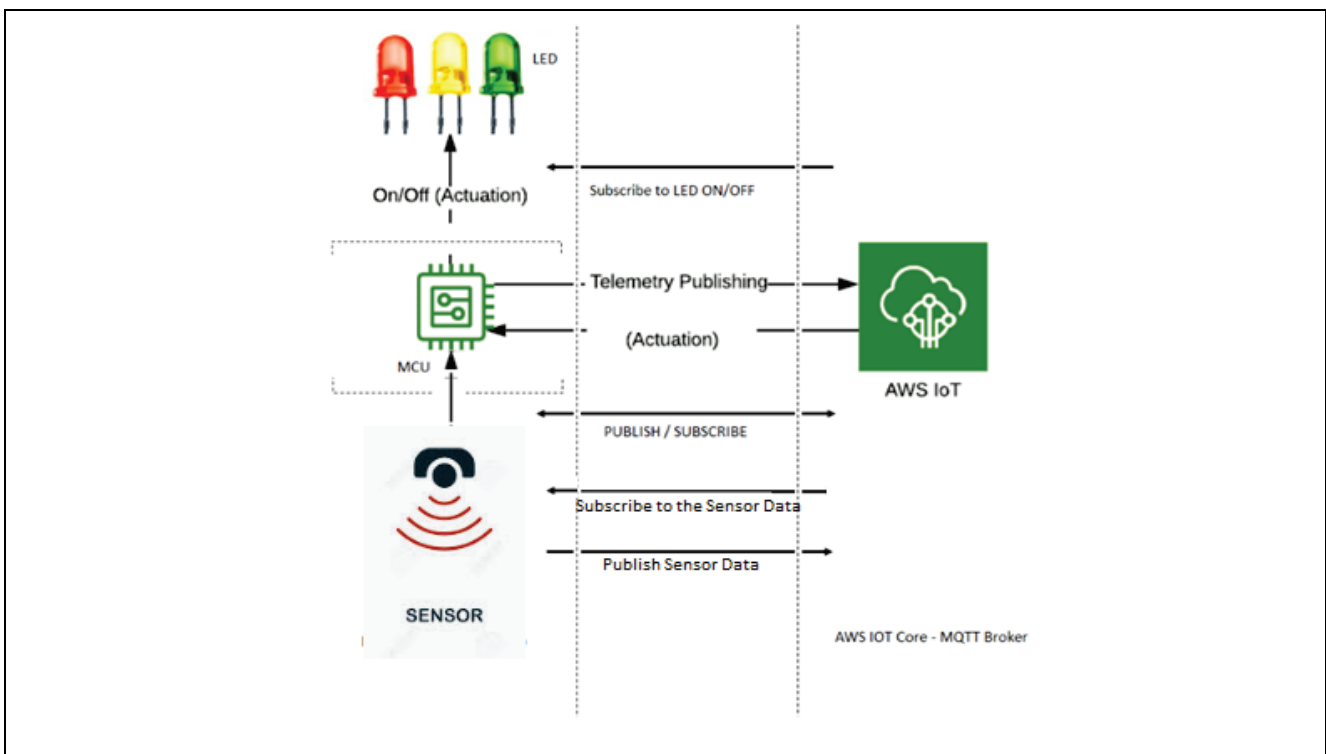


Figure 6. MQTT Publish/Subscribe to/from AWS IoT Core

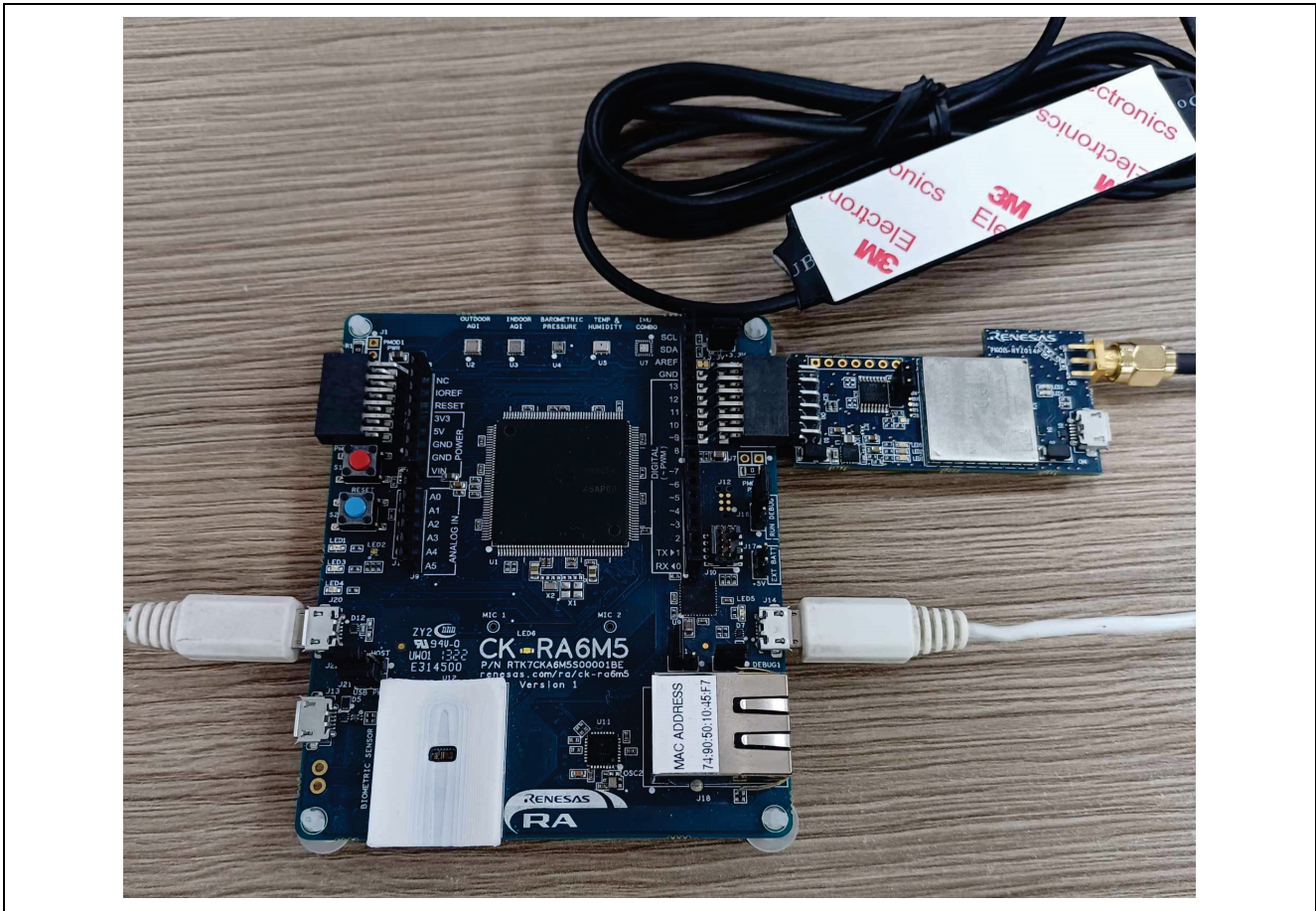


Figure 7. Hardware Setup

### 4.2 MQTT/TLS Application Software Overview

The following files from this application project serve as a reference, as shown in Table 3.

Table 3. Application Project Files

No.	Filename	Purpose
1.	src/app_thread_entry.c	Contains initialization code and has the main thread used in Cloud Connectivity application.
2.	src/cellular_setup.c	Contains Cellular Specific init functions and data structures.
3.	src/common_init.c	Contains code used to initialize common peripherals across the project.
4.	src/common_init.h	Contains macros, data structures, and functions prototypes used to initialize common peripherals across the project.
5.	src/common_utils.c	Contains code commonly used across the project.
6.	src/common_utils.h	Contains macros, data structures, and functions prototypes commonly used across the project.
7.	src/console_thread_entry.c	Contains the code for command line interface and flash memory operations.
8.	src/icm.h	Contains user defined data types and function prototypes which have implementation in RA_ICM20948.c
9.	src/ICM_20948.c	Contains driver codes for the 9 Axis sensor (Gyroscope, Accelerometer, Magnetometer).

No.	Filename	Purpose
10.	src/ICM_20948.h	Contains the Data structure function prototypes for the 9 Axis sensor (Gyroscope, Accelerometer, Magnetometer).
11.	src/ICP_10101.c	Contains the driver codes for Barometric Pressure and Temperature Sensor.
12.	src/ ICP_10101.h	Contains the Data structure and function prototypes for Barometric Pressure and Temperature Sensor.
13.	src/icp.h	Contains user defined data types and function prototypes which have implementation in RA_ICP10101.c
14.	src/mqtt_demo_helpers.c	Contains code and functions used in MQTT interface for Cloud Connectivity.
15.	src/mqtt_demo_helpers.h	Accompanying header for exposing functionality provided by mqtt_demo_helpers.c.
16.	src/oximeter_thread_entry.c	Contains codes for oximeter sensor thread's operation.
17.	src/oximeter.c	Contains codes for oximeter sensor's initialization and measurement.
18.	src/oximeter.h	Contains the Data structure and function prototypes for the oximeter sensor.
19.	src/r_typedefs.h	Contains the common derived data types
20.	src/RA_HS3001.c	Contains the code and function for Renesas Relative Humidity and Temperature Sensor.
21.	src/RA_HS3001.h	Contains the common data structure's function prototypes for the Renesas Relative Humidity and Temperature sensors.
22.	src/RA_ICM20948.c	Contains codes for 9 Axis sensor (Gyroscope, Accelerometer, Magnetometer) sensor's initialization and measurement.
23.	src/RA_ICP10101.c	Contains codes for Barometric Pressure and Temperature sensor's initialization and measurement.
24.	src/RA_ZMOD4XXX_Common.c	Contains the common code for the Renesas ZMOD sensors
25.	src/RA_ZMOD4XXX_Common.h	Contains the common data structure's function prototypes for the Renesas ZMOD sensors
26.	src/RA_ZMOD4XXX_IAQ1stGen.c	Contains the common code for the Renesas ZMOD Internal Air Quality sensors
27.	src/RA_ZMOD4XXX_OAQ1stGen.c	Contains the common code for the Renesas ZMOD Outer Air Quality sensors
28.	src/RmcI2C.c	Contains the I2C wrapper functions for the third-party sensors not integrated with FSP
29.	src/RmcI2C.h	Contains the I2C function prototypes for wrapper functions for the third-party sensors not integrated with FSP
30.	src/sensor_thread_entry.c	Contains the Code to access the Sensor data from the different sensors and order topic to publish.
31.	src/uart_CATM.c	Contains the code to access the UART interface to the CATM module for back access the SIM info for activation

No.	Filename	Purpose
32.	src/uart_CATM.h	Contains the Function prototypes to access the UART interface to the CATM module for back access the SIM info for activation
33.	src/user_choice.c	Contains the code for user's choice of sensors and user configurations
34.	src/user_choice.h	Contains the Function prototypes for the Sensor and its user configuration for the different sensors and its data accessibility.
35.	src/usr_config.h	To customize the user configuration to run the application.
36.	src/usr_data.h	Accompanying header file for the application thread.
37.	src/usr_hal.c	Contains data structures and functions used for the Hardware Abstraction Layer (HAL) initialization and associated utilities.
38.	src/usr_hal.h	Accompanying header for exposing functionality provided by <code>usr_hal.c</code> .
39.	src/zmod_thread_entry.c	Contains the code for indoor air and outdoor air quality sensors
40.	src/SEGGER_RTT/SEGGER_RTT.c	Implementation of SEGGER real-time transfer (RTT) which allows real-time communication on targets which support debugger memory accesses while the CPU is running.
41.	src/SEGGER_RTT/SEGGER_RTT.h	
42.	src/SEGGER_RTT/SEGGER_RTT_Conf.h	
43.	src/SEGGER_RTT/SEGGER_RTT_printf.c	
44.	src/backoffAlgorithm/backoff_algorithm.c	Retry algorithms with random back off for the next retry attempt
45.	src/backoffAlgorithm/backoff_algorithm.h	Retry algorithms with random back off for the next retry attempt header file
46.	src/subscription_manager/mqtt_subscription_manager.c	MQTT Subscription manager, which handles the callback
47.	src/subscription_manager/mqtt_subscription_manager.h	Associated header file for MQTT Subscription manager, which handles the callback.
48.	src/console_menu/console.c	Contains data structures and functions used to print data on console using UART
49.	src/console_menu/console.h	Contains the Function prototypes used to print data on console using UART
50.	src/console_menu/menu_catm.c	Contains functions to get SIM info of the CATM1 from main menu on CLI
51.	src/console_menu/menu_catm.h	Contains function prototypes to get SIM info of the CATM1 from main menu on CLI
52.	src/console_menu/menu_flash.c	Contains data structures and functions used to provide CLI flash memory related menu
53.	src/console_menu/menu_flash.h	Contains the Function prototypes and macros used to provide CLI flash memory related menu
54.	src/console_menu/menu_kis.c	Contains functions to get the FSP version, get UUID and help option for main menu on CLI
55.	src/console_menu/menu_kis.h	Contains the function prototypes and macros used to get fsp version, get uuid and help option for main menu on CLI
56.	src/console_menu/menu_main.c	Contains data structures and functions used to provide CLI main menu options
57.	src/console_menu/menu_main.h	Contains the Function prototypes and macros used to provide CLI main menu options

No.	Filename	Purpose
58.	src/flash/ flash_hp.c	Contains data structures and functions used to perform flash memory related operations
59.	src/flash/ flash_hp.h	Contains the Function prototypes and macros used to perform flash memory related operations
60.	src/ob1203_bio/KALMAN/kalman.c	Contains algorithm for Heart Rate, Blood Oxygen Concentration, Pulse Oximetry, Proximity, Light and Color Sensor sample calculations
61.	src/ob1203_bio/KALMAN/kalman.h	
62.	src/ob1203_bio/SAVGOL/SAVGOL.c	
63.	src/ob1203_bio/SAVGOL/SAVGOL.h	
64.	src/ob1203_bio/SPO2/SPO2.c	
65.	src/ob1203_bio/SPO2/SPO2.h	
66.	src/ob1203_bio/ob1203_bio.c	Contain codes for ob1203 sensor's implementation to use with FSP stacks.
67.	src/ob1203_bio/ob1203_bio.h	Contain user data structure and function prototypes used in ob1203_bio.c
68.	src/I2C/i2c.c	Contains data structures and functions used for I2C communication
69.	src/I2C/i2c.h	Contains the Function prototypes and macros used for I2C communication
70.	src/hal_entry.c	Contains hal level functions used in the application

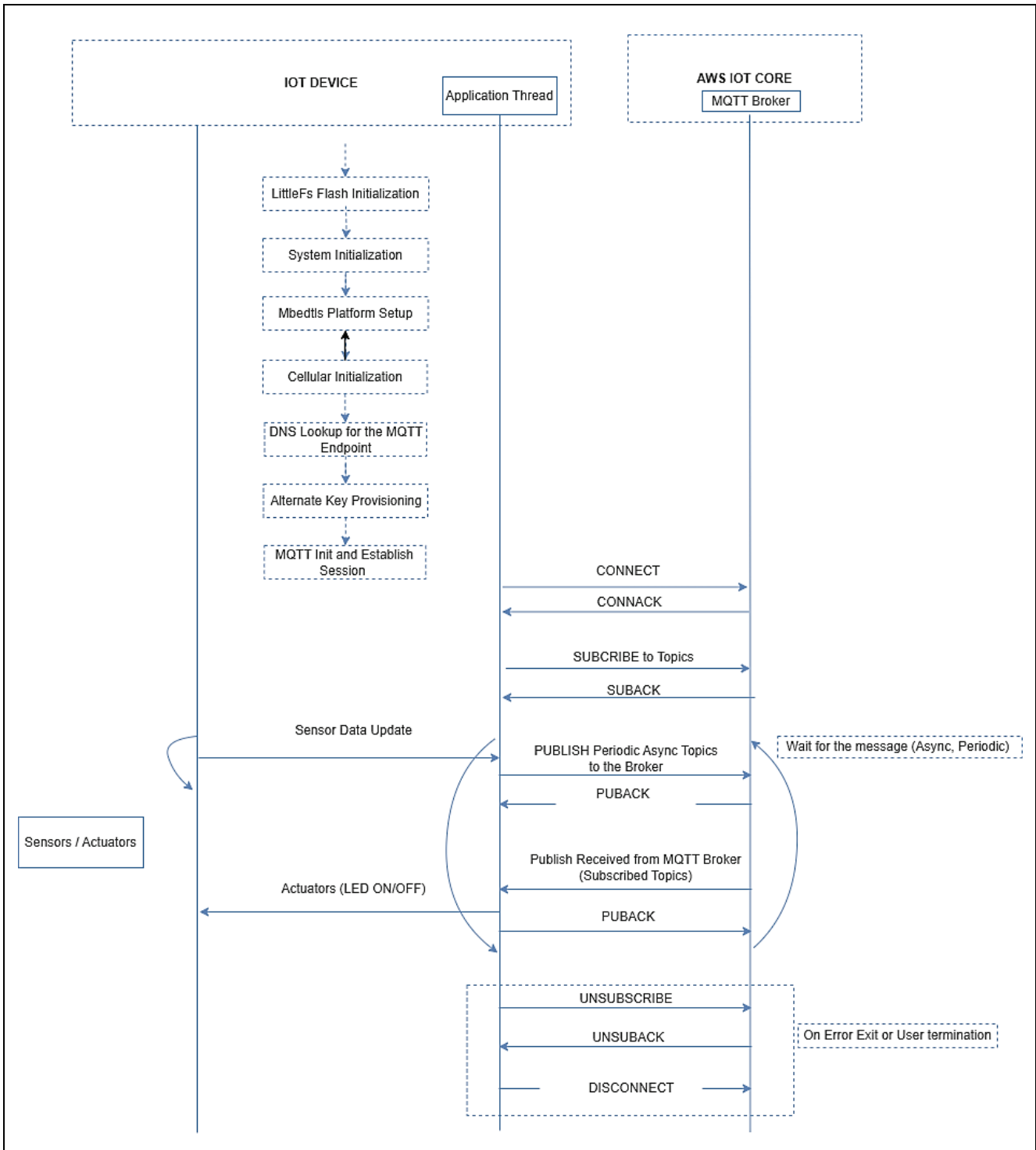


Figure 8. Application Example Implementation Details

### 4.3 Creating the Application Project using the FSP Configurator

Complete steps to create the project from the start using the e<sup>2</sup> studio and FSP configurator. Table 4 shows the step-by-step process in creating the project. It is assumed that the user is familiar with the e<sup>2</sup> studio and FSP configurator. Launch the installed e<sup>2</sup> studio for the FSP.

Table 4. Step-by-step Details for Creating the Application Project for Cellular

Steps	Intermediate Steps
1 Project Creation:	File → New → C/C++ Project

	Steps	Intermediate Steps
2	<b>Project Template:</b>	<b>Templates for New RA C/C++ Project</b> → <b>Renesas RA C/C++ Project</b> → <b>Next</b>
3	<b>e<sup>2</sup> studio - Project Configuration (RA C Executable Project)</b> →	<b>Project Name (Name for the Project)</b> Note: Input your desired name for the project -> <b>Next</b>
4	<b>Device Selection</b> →	FSP Version: <b>5.0.0</b> Board: <b>CK-RA6M5</b> Device: <b>R7FA6M5BH3CFC</b> Language: C
5	<b>Select Tools</b>	Toolchain: <b>GNU ARM Embedded</b> (Default) Toolchain version: (12.2.1.arm-12-mpacbti-34 or newer) Debugger: <b>J-Link ARM</b> → <b>Next</b>
5a	<b>Project Type Selection</b>	Flat (Non-TrustZone) Project → <b>Next</b>
6	<b>Build Artifact and RTOS Selection</b>	Artifact Selection: <b>Executable</b> RTOS Selection: FreeRTOS(v10.6.1+fsp.5.0.0) → <b>Next</b>
6a	<b>Project Template Selection</b>	<b>Project Template Selection: FreeRTOS – Minimal – Static Allocation</b> → <b>Finish</b>
7	<b>Clock</b>	<b>HOCO 20MHz</b> → <b>PLL Src: HOCO</b> → <b>PLL Div/2</b> → <b>PLL Mul x20.0</b> → <b>PLL 200MHz</b>
8	Create and configure for App Thread	
	<b>Stacks Tab</b> →	<b>Threads</b> → <b>New Thread</b>
	<b>Config Thread Properties</b> →	
		Symbol: <b>app_thread</b>
		Name: <b>App Thread</b>
		Stack size (bytes): <b>0x12000</b>
		Priority: <b>3</b>
		Thread Context: <b>NULL</b>
		Memory Allocation: <b>Static</b>
8a	Generic RTOS configs under thread (Additional configuration on top of the Default Config provided by FSP)	
	<b>Common</b> → <b>General</b>	Use Mutexes: <b>Enabled</b> Use Recursive Mutexes: <b>Enabled</b>
	<b>Common</b> → <b>Memory Allocation</b>	Support Dynamic Allocation: <b>Enabled</b> Total Heap Size: <b>0x20000</b>
	<b>Common</b> → <b>Optional Functions</b>	xTimerPendFunctionCall () Function: <b>Enabled</b>
9	Add the Heap Implementation in <b>HAL/Common</b>	
	<b>New Stack</b> →	<b>RTOS</b> → <b>FreeRTOS Heap 4</b>
10	Adding the AWS MQTT Wrapper Module to the Application Thread	
	Note: Now the Newly created thread (App Thread) is ready to add new stack (Here the AWS Core MQTT is added)	
	<b>New Stack</b> →	<b>Networking</b> → <b>AWS Core MQTT</b>
10a	Under the <b>AWS Transport Interface on MbedTLS/PKCS11</b> → <b>Add Sockets Wrapper</b> , add	<b>New</b> → <b>AWS Cellular Sockets Wrapper</b>
10b	Under the <b>SCE Compatibility Mode</b> → <b>Add Key Injection for PSA Crypto (Optional)</b> , add	<b>New</b> → <b>Key Injection for PSA Crypto</b>
10c	<b>AWS Core MQTT</b> →	<b>Common</b> → <b>Retry count for reading CONNACK from network</b> → <b>10</b>
11	Adding persistent storage support for AWS PKCS11 and resolve the error in the configurator by selecting the Heap size in the BSP Tab.	



	Steps	Intermediate Steps
	Under the MbedTLS (Crypto only) → Add Persistent Storage on LittleFS (Optional) → BSP Tab → RA Common →	Use → LittleFS  Heap size (bytes): <b>0x20000</b>
11a	LittleFS on Flash →	Block count → <b>(BSP_DATA_FLASH_SIZE_BYTES/256)</b>
12	Some dependency related to TLS Support are needed to be resolved to remove the error in the FSP configurator by modifying the <b>MbedTLS (Crypto Only)</b> property settings.	
	Common → Platform →	MBEDTLS_PLATFORM_MEMORY: <b>Define</b>
	Common → General →	MBEDTLS_THREADING_C: <b>Define</b>
	Common → General →	MBEDTLS_THREADING_ALT: <b>Define</b>
	Common → Public Key Cryptography (PKC) →	ECC → MBEDTLS_ECDH_C: <b>Define</b>
	Common → Hardware acceleration → Public key cryptography (PKC)	RSA 3072 verify: <b>Enabled</b>
	Common → Hardware acceleration → Public key cryptography (PKC)	RSA 4096 verify: <b>Enabled</b>
	Common → Storage →	MBEDTLS_FS_IO: <b>Define</b>
	Common → Storage →	MBEDTLS_PSA_CRYPT_STORAGE_C: <b>Define</b>
	Common → Storage →	MBEDTLS_PSA_ITS_FILE_C: <b>Define</b>
	Common → Message Authentication Code (MAC) →	MBEDTLS_CMAC_C: <b>Define</b>
13	<b>AWS Cellular Sockets Wrapper Configuration</b> Note: This is only applicable for the Cellular application project. Most of the default settings remain the same, except few of the default configuration needs to be change	
	AWS Cellular Interface on RYZ(rm_cellular_ryz_aws) →	Module Reset Pin (Port Number): <b>04</b> Module Reset Pin (Pin Number): <b>09</b>
13a	AWS Cellular Interface Common → Common	EDRX List Max Size: <b>16</b> RAT Priority Count: <b>1</b> Comm Interface Receive Timeout: <b>200</b> Static Allocation Context: <b>Enabled</b> Comm Interface Static Allocation Context: <b>Enabled</b> Static Socket Context: <b>Enabled</b>
14	<b>Cellular Comm Interface on UART</b>	
	Name →	<b>g_cellular_comm_interface_on_uart</b>
	Common →	Receive Buffer: <b>65536</b> Receive Transfer Size: <b>512</b>
15	<b>g_uart0 UART</b>	
	Common →	FIFO Support: <b>Enable</b> DTC Support: <b>Enable</b> Flow Control Support: <b>Enable</b>
	<b>Module g_uart0 UART</b>	
	<b>General</b>	Name: <b>g_uart0</b> Channel: <b>0</b>
	<b>Baud</b>	Baud Rate: <b>921600</b> Baud Rate Modulation: <b>Enabled</b>
	<b>Flow Control</b>	Software RTS Port: <b>04</b> Software RTS Pin: <b>12</b>
	<b>Interrupts</b>	Receive Interrupt Priority: <b>Priority 1</b> Transmit Data Empty Interrupt Priority: <b>Priority 2</b> Transmit End Interrupt Priority: <b>Priority 2</b>

	Steps	Intermediate Steps
		Error Interrupt Priority: <b>Priority 2</b>
16	Adding the HAL Modules as required for the Application Project: GPT Timer0, GPT Timer1, GPT Timer2, External IRQ for 30 Seconds periodic timer, 1 second Periodic, Heartbeat Monitor Timer, respectively.	
	<b>HAL/Common Stacks</b> → <b>New Stack</b>	→ <b>System</b> → <b>Clock Generation circuit on r_cgc</b>
	Property Settings for r_cgc	Name: <b>g_cgc0</b>
	<b>HAL/Common Stacks</b> → <b>New Stack</b>	→ <b>Input</b> → <b>External IRQ Driver on r_icu</b>
	Property Settings for r_icu	Name: <b>g_sensorIRQ</b>
		Channel: <b>14</b>
		Trigger: <b>Falling</b>
		Digital Filtering: <b>Disabled</b>
		<b>Digital Filtering Sample Clock: PCLK/64</b>
		Pin Interrupt Priority: <b>Priority 2</b>
		Callback: <b>sensorOBIRQCallback</b>
	<b>HAL/Common Stacks</b> → <b>New Stack</b>	→ <b>Timers</b> → <b>Timer, General PWM r_gpt</b>
	Property Settings for r_gpt → General	Name: <b>g_timer0</b>
		Channel: <b>0</b>
		Mode: <b>Periodic</b>
		Period: <b>10</b>
		Period Unit: <b>Milliseconds</b>
	<b>Interrupts:</b>	Callback: <b>t_callback</b>
		Overflow/Crest Interrupt Priority: <b>Priority 5</b>
	<b>HAL/Common Stacks</b> → <b>New Stack</b>	→ <b>Timers</b> → <b>Timer, General PWM r_gpt</b>
	Property Settings for r_gpt → General	Name: <b>g_timer1</b>
		Channel: <b>1</b>
		Mode: <b>Periodic</b>
		Period: <b>1</b>
		Period Unit: <b>Seconds</b>
	<b>Interrupts:</b>	Callback: <b>g_user_timer_cb</b>
		Overflow/Crest Interrupt Priority: <b>Priority 5</b>
	<b>HAL/Common Stacks</b> → <b>New Stack</b>	→ <b>Timers</b> → <b>Timer, General PWM r_gpt</b>
	Property Settings for r_gpt → General	Name: <b>g_timer2</b>
		Channel: <b>2</b>
		Mode: <b>Periodic</b>
		Period: <b>1</b>
		Period Unit: <b>Milliseconds</b>
	<b>Interrupts:</b>	Callback: <b>TimerCallback</b>
		Overflow/Crest Interrupt Priority: <b>Priority 5</b>
17	<b>Modifying the BSP Settings - RA Common for (Main stack, Heap and Subclock Settings)</b>	
	Property Settings for RA Common	Main stack size(bytes): <b>0x2000</b>
		Heap size (bytes): <b>0x20000</b>
		Subclock Populated: <b>Not Populated</b>
18	Adding FreeRTOS Objects for the Application (Topic Queue needs to be created for the application – Message Queue)	
	<b>Stacks Tab</b> → <b>Objects</b> →	<b>New Object</b> → <b>Queue</b>
	Property Settings for the Queue	Symbol: <b>g_topic_queue</b>
		Item Size (Bytes): <b>65</b>
		Queue Length (Items): <b>16</b>
		Memory Allocation: <b>Static</b>
	<b>Stacks Tab</b> → <b>Objects</b> →	<b>New Object</b> → <b>Mutex</b>
	Property Settings for the Mutex	Symbol: <b>g_sens_data_mutex</b>

	Steps	Intermediate Steps
		Type: <b>Mutex</b>
	<b>Stacks Tab</b> → <b>Objects</b> → Property Settings for the Mutex	Memory Allocation: <b>Static</b> <b>New Object</b> → <b>Mutex</b> Symbol: <b>g_console_out_mutex</b> Type: <b>Mutex</b> Memory Allocation: <b>Static</b>
	<b>Stacks Tab</b> → <b>Objects</b> → Property Settings for the Mutex	<b>New Object</b> → <b>Mutex</b> Symbol: <b>g_update_console_event</b> Type: <b>Mutex</b> Memory Allocation: <b>Static</b>
	<b>Stacks Tab</b> → <b>Objects</b> → Property Settings for the Semaphore	<b>New Object</b> → <b>Binary Semaphore</b> Symbol: <b>g_ob1203_semaphore</b> Memory Allocation: <b>Static</b>
	<b>Stacks Tab</b> → <b>Objects</b> → Property Settings for the Semaphore	<b>New Object</b> → <b>Binary Semaphore</b> Symbol: <b>g_console_binary_semaphore</b> Memory Allocation: <b>Static</b>
	<b>Stacks Tab</b> → <b>Objects</b> → Property Settings for the Queue	<b>New Object</b> → <b>Queue</b> Symbol: <b>g_hs3001_queue</b> Item Size (Bytes): <b>8</b> Queue Length (Items): <b>1</b> Memory Allocation: <b>Static</b>
	<b>Stacks Tab</b> → <b>Objects</b> → Property Settings for the Queue	<b>New Object</b> → <b>Queue</b> Symbol: <b>g_iaq_queue</b> Item Size (Bytes): <b>12</b> Queue Length (Items): <b>1</b> Memory Allocation: <b>Static</b>
	<b>Stacks Tab</b> → <b>Objects</b> → Property Settings for the Queue	<b>New Object</b> → <b>Queue</b> Symbol: <b>g_oaq_queue</b> Item Size (Bytes): <b>4</b> Queue Length (Items): <b>1</b> Memory Allocation: <b>Static</b>
	<b>Stacks Tab</b> → <b>Objects</b> → Property Settings for the Queue	<b>New Object</b> → <b>Queue</b> Symbol: <b>g_icm_queue</b> Item Size (Bytes): <b>72</b> Queue Length (Items): <b>1</b> Memory Allocation: <b>Static</b>
	<b>Stacks Tab</b> → <b>Objects</b> → Property Settings for the Queue	<b>New Object</b> → <b>Queue</b> Symbol: <b>g_icp_queue</b> Item Size (Bytes): <b>16</b> Queue Length (Items): <b>1</b> Memory Allocation: <b>Static</b>
	<b>Stacks Tab</b> → <b>Objects</b> → Property Settings for the Queue	<b>New Object</b> → <b>Queue</b> Symbol: <b>g_ob1203_queue</b> Item Size (Bytes): <b>10</b> Queue Length (Items): <b>1</b> Memory Allocation: <b>Static</b>
19	<b>Stacks Tab (Part of the FSP Configurator)</b> →	<b>Threads</b> → <b>New Thread</b>
	<b>Config Thread Properties</b> →	Symbol: <b>sensor_thread</b> Name: <b>Sensor Thread</b> Stack size: <b>8192 Bytes</b>

	Steps	Intermediate Steps
		Priority: <b>4</b>
		Thread Context: <b>NULL</b>
		Memory Allocation: <b>Static</b>
20	Adding the HS300X Sensor Module and ZMOD4510 OAQ sensor module to the Sensor Thread	
	<b>New Stack</b> →	<b>Sensor</b> → <b>HS300X Temperature/Humidity Sensor</b>
	<b>Config HS300X sensor</b> →	Name: <b>g_hs300x_sensor0</b>
		Callback: <b>hs300x_callback</b>
	<b>Under I2C Shared Bus</b> → <b>Add I2C Communications Peripheral</b> →	<b>New</b> → <b>I2C Master(r_iic_master)</b>
	<b>Config for I2C Master</b> →	Name: <b>g_i2c_master0</b>
		Channel: <b>0</b>
		Rate: <b>Fast-mode</b>
		Interrupt Priority Level: <b>Priority 5</b>
	<b>New Stack</b> →	<b>Sensor</b> → <b>ZMOD4XXX Gas Sensor</b>
	<b>Config ZMOD4XXX sensor</b> →	Name: <b>g_zmod4xxx_sensor1</b>
		Callback: <b>zmod4xxx_comms_i2c1_callback</b>
		IRQ Callback: <b>zmod4xxx_irq1_callback</b>
	<b>Under the ZMOD4XXX Gas Sensor</b> → <b>Add Requires ZMOD Library</b> →	<b>New</b> → <b>ZMOD4510 OAQ 1st Generation</b>
	<b>Under the ZMOD4510 OAQ 1st Generation</b> → <b>I2C Communication Device</b> → Property Settings for <b>I2C Communication Device</b>	Name: <b>g_comms_i2c_device2</b>
	<b>Under the I2C Communication Device</b> → <b>Add I2C Share Bus</b> →	<b>Use</b> → <b>g_comms_i2c_bus2 I2C Shared Bus</b>
	<b>Under the ZMOD4XXX Gas Sensor</b> → <b>Add IRQ Driver for measurement</b> →	<b>New</b> → <b>External IRQ</b>
	<b>Config External IRQ</b>	Name: <b>g_external_irq1</b>
		Channel: <b>15</b>
		Trigger: <b>Falling</b>
		Pin Interrupt Priority: <b>Priority 12</b>
	<b>Config Pins</b>	IRQ15: <b>P404</b>
	Adding ICM-20948 and ICP10101 sensors to the Sensor Thread. Note: FSP does not provide an integrated module for ICM-20948 and ICP10101 sensors. This needs to be integrated via the I2C communication device manually. Also its related sensor driver code needs to be added to the src folder.	
	<b>New Stack</b> →	<b>Connectivity</b> → <b>I2C Communication Device</b>
	<b>Config I2C Communication Device</b> →	Name: <b>g_comms_i2c_device5</b>
		Slave Address: <b>0x68</b>
		Callback: <b>ICM_comms_i2c_callback</b>
	<b>Add I2C Shared Bus</b> →	<b>Add I2C Shared Bus</b> → <b>Use</b> → <b>g_comms_i2c_bus0 I2C Shared Bus</b>
	<b>Module g_i2c_master0 I2C Master</b> →	Rate: <b>Fast-mode</b>
21	Adding I2C Communication Device (for ICP10101) into Sensor Thread	
	<b>New Stack</b> →	<b>Connectivity</b> → <b>I2C Communication Device</b>
	<b>Config I2C Comm Device</b> →	Name: <b>g_comms_i2c_device4</b>
		Slave Address: <b>0x63</b>
		Callback: <b>ICP_comms_i2c_callback</b>

	Steps	Intermediate Steps
	Add I2C Shared Bus→	Add I2C Shared Bus→Used→g_comms_i2c_bus0 I2C Shared Bus
	Module g_i2c_master0 I2C Master	Rate: Fast Mode
22	Stacks Tab (Part of the FSP Configurator) →	Threads → New Thread
	Config Thread Properties→	Symbol: <b>oximeter_thread</b>
		Name: <b>Oximeter Thread</b>
		Stack size: <b>2048 Bytes</b>
		Priority: <b>4</b>
		Thread Context: <b>NULL</b>
Memory Allocation: <b>Static</b>		
22a	Add the OB1203 sensor module, PPG mode to the Oximeter Thread.	
	New Stack →	Sensor → OB1203 Light/Proximity/PPG Sensor
	Config OB1203 Light/Proximity/PPG Sensor →	Name: g_ob1203_sensor0
	Under the OB1203 Light/Proximity/PPG Sensor → Add Requires OB1203 Operation mode →	New → OB1203 PPG mode
	Under the OB1203 PPG mode → I2C Communication Device →	Name: g_comms_i2c_device3
	Under the I2C Communication Device → Add I2C Share Bus →	Used→ g_comms_i2c_bus0 I2C Shared Bus
	Under the OB1203 Light/Proximity/PPG Sensor → Add IRQ Driver for measurement →	New → External IRQ
	Config for External IRQ →	Name: g_external_irq14
Channel: <b>14</b>		
	Trigger: <b>Falling</b>	
Config Pins →	IRQ14: <b>P403</b>	
22b	Add the OB1203 sensor module, Proximity mode to the Oximeter Thread.	
	New Stack →	Sensor → OB1203 Light/Proximity/PPG Sensor
	Config OB1203 Light/Proximity/PPG Sensor →	Name: g_ob1203_sensor1
	Under the OB1203 Light/Proximity/PPG Sensor → Add Requires OB1203 Operation mode →	New → OB1203 Proximity mode
	Under the OB1203 Proximity mode → I2C Communication Device →	Name: g_comms_i2c_device6
	Under the I2C Communication Device → Add I2C Share Bus →	Use → g_comms_i2c_bus0 I2C Shared Bus
	Under the OB1203 Light/Proximity/PPG Sensor → Add IRQ Driver for measurement →	Use → g_external_irq14 External IRQ
24	Stacks Tab (Part of the FSP Configurator) →	Threads → New Thread
	Config Thread Properties→	Symbol: <b>zmod_thread</b>
		Name: <b>Zmod Thread</b>

	Steps	Intermediate Steps
		Stack size: <b>2048 Bytes</b>
		Priority: <b>3</b>
		Thread Context: <b>NULL</b>
		Memory Allocation: <b>Static</b>
25	Adding the ZMOD4XXX sensor module to the Zmod Thread Note: ZMOD4410 IAQ Sensor is configured (part of the FSP configurator)	
	<b>New Stack →</b>	<b>Sensor → ZMOD4XXX Gas Sensor</b>
	<b>Config ZMOD4XXX sensor→</b>	Name: <b>g_zmod4xxx_sensor0</b>
		Callback: <b>zmod4xxx_comms_i2c_callback</b>
		IRQ Callback: <b>zmod4xxx_irq0_callback</b>
	<b>Under the ZMOD4XXX Gas Sensor → Add Requires ZMOD Library →</b>	<b>New → ZMOD4410 IAQ 1st Generation</b>
	<b>Under the ZMOD4410 IAQ 1st Generation → I2C Communication Device → Property Settings for I2C Communication Device</b>	Name: <b>g_comms_i2c_device1</b>
	<b>Under the I2C Communication Device → Add I2C Share Bus →</b>	<b>Use → g_comms_i2c_bus2 I2C Shared Bus</b>
25a	<b>Under the ZMOD4XXX Gas Sensor → Add IRQ Driver for measurement →</b>	<b>New → External IRQ</b>
	<b>Config External IRQ</b>	Name: <b>g_external_irq0</b>
		Channel: <b>4</b>
		Trigger: <b>Falling</b>
	<b>Config Pins</b>	Pin Interrupt Priority: <b>Priority 3</b>
		IRQ04: <b>P402</b>
26	Create and add Console processing Thread	
	<b>Stacks tab (Part of the FSP Configurator)</b>	<b>Threads → New Thread</b>
	<b>Config Thread Properties→</b>	Symbol: <b>console_thread</b>
		Name: <b>Console Thread</b>
		Stack size: <b>4096 Bytes</b>
		Priority: <b>3</b>
		Thread Context: <b>NULL</b>
		Memory Allocation: <b>Static</b>
27	Adding Uart to Console Thread	
	<b>New Stack →</b>	<b>Connectivity→ UART</b>
	<b>Config Common →</b>	FIFO Support: <b>Enable</b>
		DTC Support: <b>Enable</b>
		Flow Control Support: <b>Enable</b>
	<b>Config General →</b>	Name: <b>g_console_uart</b>
		Channel: <b>5</b>
		Data Bits: <b>8bits</b>
		Parity: <b>None</b>
		Stop Bits: <b>1bit</b>
	<b>Config Baud→</b>	Baudrate: <b>115200</b>
	<b>Config Interrupts →</b>	Callback: <b>user_uart_callback</b>
	<b>Config Pins →</b>	TXD5: <b>P501</b>

	Steps	Intermediate Steps
		RXD5: <b>P502</b>
28	Adding Flash to Console Thread	
	<b>New Stack</b> →	<b>Storage</b> → <b>Flash</b>
		Name: <b>user_flash</b>
		Data Flash Background Operation: <b>Disabled</b>
		Callback: <b>flash_callback</b>
		Flash Ready Interrupt Priority: <b>Priority 2</b>
	Flash Error Interrupt Priority: <b>Priority 2</b>	
29	Adding CATM1 Uart to Console Thread	
	<b>New Stack</b> → <b>Config General</b> →	<b>Connectivity</b> → <b>UART</b>
		Name: <b>g_catm1_uart</b>
		Channel: <b>0</b>
		Data Bits: <b>8bits</b>
		Parity: <b>None</b>
		Stop Bits: <b>1bit</b>
	<b>Config Baud</b> →	Baudrate: <b>921600</b>
	<b>Config Interrupts</b> →	Callback: <b>catm1_uart_callback</b>
	<b>Config Pins</b> →	TXD: <b>P411</b>
RXD: <b>P410</b>		
CTSRTS0: <b>P413</b>		
30	Add linker flag and Enable "Use float with nano printf" to print float values.	
	<b>Project</b> → <b>Properties</b> → <b>C/C++ Build</b> → <b>Settings</b> → <b>Tool Settings tab</b> → <b>GNU ARM Cross C Linker</b> → <b>Miscellaneous</b>	→Check the box: Use float with nano printf (-u _printf_float) <b>Other linker flags: --specs=rdimon.specs</b>

The above configuration is a prerequisite to generate the required stack and features for the cloud connectivity application provided with this application note. Once the **Generate Project Content** button is clicked, it generates the source code for the project. The generated source code contains the required drivers, stack, and middleware. The user application files must be added into the `src` folder.

**Note:** `app_thread_entry.c`, `sensor_thread_entry.c`, `oximeter_thread_entry.c`, `zmod_thread_entry.c` and `console_thread_entry.c` are the auto generated files as part of the project creation. Users are required to add code to this file.

**Note:** To run the application with the supplied code, `app_thread_entry.c`, `sensor_thread_entry.c`, `oximeter_thread_entry.c`, `zmod_thread_entry.c` and `console_thread_entry.c` are available parts of this application note bundle can be merged or overwritten to the auto generated files.

**Note:** FSP generated code must be called/used from the application, while some of the middleware needs to be called exclusively as part of the application for proper initialization. For instance, the `Mbedtls_platform_setup()` call initializes the SCE and TRNG.

For validation of the created project, the same source files listed in section MQTT/TLS Application Software Overview (as shown in Table 3) may be added. Users are required to add the directory path and subdirectory for proper compilation. Following include paths need to be added to **Project** → **Properties** → **C/C++ Build** → **Settings** → **Tool Settings tab** → **GNU Arm Cross C Compiler** → **Includes** → **Include paths (-I)**. Refer to the enclosed project for more details.

```
"${workspace_loc}/${ProjName}/src/backoffAlgorithm}"
"${workspace_loc}/${ProjName}/src/subscription_manager}"
"${workspace_loc}/${ProjName}/src/SEGGER_RTT}"
"${workspace_loc}/${ProjName}/src/ob1203_bio}"
```

The details of the configurator from the default settings to changed settings are described in the following sections, including the reason for the change.

## 4.4 MQTT/TLS Configuration

This section describes the MQTT and TLS module configuration settings that are done as part of this application example.

The following table lists changes made to a default configuration populated by the RA Configurator.

**Table 5. Default Configuration for CK-RA6M5**

Property	Original Value	Changed Value	Reason for Change
<b>Application Thread</b>			
Common → General → Use Mutexes	Disabled	Enabled	This requirement is set by the AWS IOT SDK C stack
Common → Memory Allocation → Support Dynamic Allocation	Disabled	Enabled	This requirement is set by the AWS IOT SDK C stack
Common → Memory Allocation → Total Heap Size	0	0x20000	Heap required for the FreeRTOS, AWS IOT SDK, Mbed TLS
<b>Mbed TLS (Crypto Only)</b>			
Platform → MBEDTLS_PLATFORM_MEMORY	Undefine	Define	This selection is required to support the MbedTLS.
General → MBEDTLS_THREADING_ALT	Undefine	Define	This selection is required to support the MbedTLS to plug in any thread library.
General → MBEDTLS_THREADING_C	Undefine	Define	This selection is required to support the MbedTLS to abstract the threading layer to allow easy plugging in any thread-library.
Public Key Cryptography (PKC) → ECC → MBEDTLS_ECDH_C	Undefine	Define	This selection is required to support the MbedTLS to enable the ECDH module.
<b>LittleFS (Heap Selection)</b>			
BSP → RA Common → Heap Size (bytes)	0	0x20000	Heap selection for Heap 3 and other usages with malloc.

## 5. Sensor Stabilization Time

This table gives the time required for the sensors to sense and provide the valid data to the users. Here you will see 2 columns, column 1 – when powered up for the first time and column 2 - after software or hard reset. If the system boots up from cold start, the time for the sensors to provide the valid data is up to (1 min – 4 hours), whereas if the system bootup from warm start, the time for the sensors to provide the valid data is up to (10 sec – 2 hours). For more details, refer to the specific sensor datasheet.



**Table 6. Sensor Stabilization Time**

Sensor Name	When Powered Up First Time	After Soft or Hard Reset
ZMOD4410 IAQ	Up to 1 minute	Up to 1 minute
ZMOD4510 OAQ	Up to 4 hours	Up to 2 hours
OB1203	Up to 1 minute (after placing the index finger on the sensor, it may take up to 60 seconds to sense data)	Up to 10 seconds (after placing the index finger on the sensor, it may take up to 60 seconds to sense data)
HS3001	Up to 1 minute	Up to 10 seconds
ICP	Up to 1 minute	Up to 10 seconds
ICM	Up to 1 minute	Up to 10 seconds

Note: Stabilization time of the sensor provided above is from the point of sensor initialization.

## 6. MQTT/TLS Module Next Steps

- For setting up a client using a device certificate signed by a preferred CA certificate, refer to the link: <https://docs.aws.amazon.com/iot/latest/developerguide/device-certs-your-own.html>
- For using a self-signed certificate to configure AWS, refer to the link: <https://developer.amazon.com/docs/custom-skills/configure-web-service-self-signed-certificate.html>

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## 8. Known Issues and Troubleshooting

- This section talks about the known FSP and tool related issues. More details can be found at the link: <https://github.com/renesas/fsp/issues>.
- It is recommended to use the dashboard with Microsoft edge browser, it does not work properly with Google Chrome browser.
- In case of unstable cellular connection or loss of MQTT connection, connect the USB on the RYZ014A Pmod to the PC to provide additional power to the module. Refer to [RYZ014A Pmod Errata](#).
- When running debug on e2studio, if the application is rerun multiple times, it might randomly occur issue with i2c communication of OB1203 sensor. Users need to reconnect the USB cable (J14) to reset OB1203 sensor and run the application again.

## 9. Debugging

Enable the `USR_LOG_LVL (LOG_DEBUG)` macro in the application project for additional information of the error during debugging.

**Website and Support**

Visit the following vanity URLs to learn about key elements of the RA family, download components and related documentation, and get support.

CK-RA6M5 Kit Information	<a href="https://renesas.com/ra/ck-ra6m5">renesas.com/ra/ck-ra6m5</a>
RA Cloud Solutions	<a href="https://renesas.com/cloudsolutions">renesas.com/cloudsolutions</a>
RA Product Information	<a href="https://renesas.com/ra">renesas.com/ra</a>
RA Product Support Forum	<a href="https://renesas.com/ra/forum">renesas.com/ra/forum</a>
RA Flexible Software Package	<a href="https://renesas.com/FSP">renesas.com/FSP</a>
Renesas Support	<a href="https://renesas.com/support">renesas.com/support</a>

**Revision History**

Rev.	Date	Description	
		Page	Summary
1.01	Jun.11.22	—	Initial release
1.02	Mar.15.23	—	Updated to FSP 4.2.0
1.03	May.08.23	—	Support for TruPhone SIM and update to FSP 4.4.0
1.10	Feb.01.24	—	Updated to FSP 5.0.0

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